

Welcome to our comprehensive catalogue of high-quality melamine paper and surface solutions. We provide top-quality materials for furniture, interior design, and construction.

## **Melamine Paper:**

Impregnated with premium melamine resin, offers a versatile and robust decorative solution.

**Aesthetic Versatility:** Available in a vast array of colors, patterns, and realistic wood grains, catering to diverse design preferences.

**Technical Specifications:**

**Weight:** 70-120 g/m<sup>2</sup>, with customizable options.

**Base Paper:** High-quality alpha-cellulose.

**Resin Content:** 40-60%, optimized for performance.

**Finishes:** Matte, satin, and gloss, tailored to your aesthetic requirements.

**Size:** 4x8ft, 4x9ft, 4x10ft.

## **Melamine Board:**

Our melamine boards provide a ready-to-use, durable surface for various applications.

**Substrates:** Particleboard, MDF, plywood, blockboard.

**Dimensions:** 1220x2440mm, 1220x2745mm, 1300x2800mm.

**Thickness:** 2-25mm.

**Adhesive:** E2, E1, E0 compliant.

**Finishing Seamless with PVC Edge Banding & Rolls:**

## **PVC Edge Banding:**

Perfect color matching for all melamine board designs.

Thickness: 0.40-3mm.

Width: 15-65mm (custom widths available).

Packing: 100 meters/roll.

Minimum Order: 3000 meters per color/size.

Easy processing with standard hot melt adhesives.

## **PVC Rolls:**

Matching colors to our melamine paper range.

Thickness: 0.15-0.35mm, Width: 1300mm.

Finished Board size: 4x8ft (1220x2440mm)

Substrates: MDF, particleboard, plywood, blockboard.

Density: 1.35g/cm<sup>3</sup>

Thickness: 3-18mm.

**High-Performance Laminates:**

Thickness: 0.50-1.0mm.

Dimensions: 4x8ft (1230x2450mm), 4x9ft (1230x2800mm), 4x10ft (1230x3050mm).

Density: 1.4-1.5g/cm<sup>3</sup>.

Adhesive: Mixed glue/WBP glue.

Surface Finishes: Matt, embossed, textured, glossy, high glossy.

Key Features & Processing:

Embossing: Customizable textures to meet your specific requirements.

Wood Decors: High lightfastness inks with UV lacquer for scratch resistance.

Primer: Backside primed for optimal adhesion with EVA/PUR hot melt adhesives.

Chipboard Humidity: 7-10%.

Adhesive Application: 200-250 gr/m<sup>2</sup>.

Processing Temperature: 180-220 °C.

Feed Rate: 12-30 m/min.

Disclaimer:

The information provided is for general guidance. Product properties may vary. Consult specific product data sheets for accuracy. Testing is advised for intended applications.